Recommendation for measuring high-power LED primary lens surface temperature with thermocouples

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## Contents

Abstract ........................................................................................................................... 4  
Introduction .................................................................................................................. 5  
Procedure.................................................................................................................... 5  
  - Calibration of thermocouples ............................................................................. 5  
  - Thermocouple shielding .................................................................................... 5  
  - Recalibration after shielding ............................................................................ 7  
  - Reliability of the shielding ............................................................................... 7  
    - Thermal interface material ........................................................................... 8  
Conclusion .................................................................................................................. 10  
References .................................................................................................................. 10  
Acknowledgments ....................................................................................................... 11  
About ASSIST .......................................................................................................... 11  
Appendix A .................................................................................................................. 12  
Appendix B .................................................................................................................. 13
Abstract

This issue of ASSIST recommends describes a method for measuring the primary lens surface temperature of high-power light-emitting diodes using a wire thermocouple.

The assessment of LED lens temperature during operation has become a necessary step in the making of reliable LEDs and systems. Using thermocouples to make temperature measurements in high radiant flux environments can lead to large errors. Results from a recent study showed that most of the error is due to absorption of visible radiant energy by the thermocouple. By wrapping the thermocouple lead wires with a suitable material to shield them from visible radiation, and by including a transparent material at the thermocouple junction to improve the thermal interface between the lens surface and the thermocouple junction bead, the measurement errors can be minimized.
Introduction

This document describes a method for measuring the primary lens surface temperature of a high-power light-emitting diode (HPLED) using a wire thermocouple. This method was developed by the Lighting Research Center (LRC) at Rensselaer Polytechnic Institute in collaboration with the Alliance for Solid State Illuminating Systems and Technology (ASSIST).

The assessment of LED lens temperature during operation has become a necessary step in the making of reliable LEDs and systems, and is typically accomplished using a thermocouple attached to the surface of the primary lens. One of the challenges in using thermocouples to measure the surface temperature of the primary lens of an HPLED is the effect of the visible radiant power emitted by the LED being absorbed by the thermocouple junction and lead wires. This absorbed radiation can lead to large errors in temperature readings (IES, 2008, 2009, 2011; Perera et al., 2013; Poorman et al., 2004; Shannon and Butler, 2003). Therefore, to obtain accurate temperature measurements, this issue of ASSIST recommends outlines a method for shielding the thermocouple lead wires from radiation. For further information on the physical phenomena and the accuracy and tolerance of temperature measurement using a shielded thermocouple, please refer to Appendix A.

Procedure

Calibration of thermocouples

First, to ensure accurate temperature measurements, the thermocouples must be calibrated according to the methods specified by the National Institute of Standards and Technology (NIST) or ASTM International, or another equivalent (refer to Appendix B for a partial list of relevant standards).

Thermocouple shielding

It is important to select an appropriate material that can be used to surround the thermocouple wires to minimize absorption of radiation from the LED source. The shielding material must have the following properties:

- White color
- Reflective (reflectivity>0.99), diffuse
- Thermally insulating
The entirety of the thermocouple lead wires, except for the thermocouple sensing junction, must be covered using the shielding material, as illustrated in Figure 1. A material such as polytetrafluoroethylene (PTFE), in the form of thin flexible sheets, is a good candidate for shielding thermocouple lead wires. However, the selected material must be tested for its transmission of radiant power, since its reflectivity is thickness dependent. If the shielding material transmits radiant power, even if it is a small amount (1%), multiple layers are recommended to ensure no radiation reaches the thermocouple wire.

Next, to increase the thermal contact between the thermocouple sensing junction and the LED primary lens surface, an appropriate interface material must be used. The interface material reduces convective heat loss from the thermocouple sensing junction to the ambient and improves the measurement accuracy and repeatability of the measured temperature values.

![Figure 1. Schematic diagram of the thermocouple shielding method for measuring primary LED lens temperature: (a) thermocouple with no shielding; (b) thermocouple with shielding and interface material.](image)

The length of the shielding along the thermocouple lead wires is application specific and should be decided based on the light-emitting angle of the LED package (Figure 2). If multiple LED packages are used in an application, the thermocouples must be shielded not only from the radiation emitted by the LED directly under the thermocouple but also from the aggregate radiation emitted by all the LED packages in the vicinity of the thermocouple wires.
**Recalibration after shielding**

The calibration procedure used initially to calibrate the thermocouples should be completed again to test and calibrate the thermocouples after shielding. This is to ensure that the shielding did not alter the thermocouple functionality; in other words, to ensure that the shielding process did not create multiple junctions due to multiple contacts created between the thermocouple lead wires. Furthermore, recalibration ensures that the sensing junction is not insulated by the shielding material.

**Reliability of the shielding**

It is recommended that the shielding on the thermocouple be adequate for the specific application with respect to the radiation flux incident on the thermocouple. Figure 3 illustrates a schematic of a setup that can be used for verifying the shielding on the thermocouple. The shielded thermocouple is placed on a surface with a known temperature and that can be changed in a controlled manner. Here, too, the same interface material (intended to be used in the application) must be used to increase the thermal contact between the shielded thermocouple and the temperature-controlled surface. The radiation emitted from a number of LED packages mounted on a translation platform that can move along the length of the shielded thermocouple is used to check if the shielding is adequate.
sufficient. It is worth noting here that the length of the thermocouple lead wire irradiated by the LEDs and the radiation level on the thermocouple lead wire during the reliability check must be similar to the length and irradiance during the actual measurement. This ensures that the shielded thermocouple measurement is within the expected tolerance of the measuring gauge and the controlled hot surface.

Figure 3. Schematic diagram of a setup used to check the thermocouple shielding

**Thermal interface material**

The thermal interface material must have suitable thermal, optical, and mechanical properties. The thermal conductivity must be similar or higher compared to the lens material to reduce the thermal resistance between the thermocouple sensing junction and the primary lens of the LED package.

Interface materials that absorb visible radiation must be avoided to ensure accurate temperature measurement. Otherwise, the interface material will absorb radiation from the LED heat-up, resulting in erroneous values. Optically clear interface materials are recommended with refractive indices similar to the primary lens material. The mechanical adhesion strength and hardness are also important since a good adhesion provides good thermal contact between the lens surface and the thermocouple sensing junction. The hardness of the thermal interface material should be such that it does not create cavities around the sensing junction (Figure 4).
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The shielding near the sensing junction should be such that no radiation enters between the shielding material and the thermocouple lead wire, as indicated in Figure 5(b). The radiation entering the cavity between the shielding material and the thermocouple lead wire increases the chance of being absorbed by the thermocouple lead wires, resulting in measurement error.

Figure 4. Schematic diagram of cavity around the thermocouple sensing junction due to manipulation of the thermocouple lead wires during testing.

Figure 5. Schematic diagram of the shielding near the sensing junction: (a) Shielding reflecting the radiation emitted by the LED (indicated by the red arrow) reducing the absorption by the thermocouple lead wires; (b) Radiation penetrating through shielding (indicated by the red arrow) which causes measurement error due to increased radiation absorption by the thermocouple lead wires.
Conclusion

The thermocouple shielding method recommended in this document reduces the absorption of radiation in the thermocouple lead wires and thus reduces the error in the measured temperature values. The amount of radiant energy absorbed by the thermocouple depends on many factors, including, irradiance, surface area (length and wire diameter) exposed to radiation, metallurgy (type of thermocouple), and the ambient surrounding the wire (convection). Therefore, to ensure sufficient shielding is provided to minimize error, it is recommended that the calibration procedure, explained earlier, is carefully done.

The thermocouple sensing junction should not be shielded because the reduction of conduction heat transfer from the lens surface temperature and the thermocouple sensing junction could result in reduced sensor sensitivity and possibly causing measurement error.

References


Acknowledgments

ASSIST and the Lighting Research Center would like to thank the following for their review and participation in the development of this publication: Ed Leubner, Joe Manahan, and Scott Beach of Cooper Crouse-Hinds; Mike Gershowitz, Maria Topete, Brandon Noska, and David Nowak of Bridgelux; Andrew Bierman, Martin Overington, and Jennifer Taylor of the Lighting Research Center.

About ASSIST

The Alliance for Solid-State Illumination Systems and Technologies (ASSIST) was established in 2002 by the Lighting Research Center as a collaboration among researchers, manufacturers, and government organizations. ASSIST’s mission is to enable the broad adoption of solid-state lighting by providing factual information based on applied research and by visualizing future applications.
Appendix A

Accurate measurement of LED lens surface temperature
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ABSTRACT
Radiant power emitted by high power light-emitting diodes (LEDs) have been steadily increasing over the past decade. High radiation, especially short wavelength, can increase the temperature and negatively affect the primary lens performance of high-power LEDs. In this regards, assessment of lens temperature during operation is important. Past studies have shown large errors when thermocouples are used for measuring temperature in high radiant flux environments. Therefore, the objective of this study was to understand the problem in using thermocouples to measure LED lens surface temperature and to find a solution to improving the measurement accuracy. A laboratory study was conducted to better understand the issue. Results showed that most of the error is due to absorption of visible radiant energy by the thermocouple. In this study, the measurements made using an infrared (IR) thermal imaging system were used as the reference temperature because the IR imaging system is unaffected by radiant flux in the visible range. After studying the thermocouple wire metallurgy and its radiation absorption properties, a suitable material was identified to shield the thermocouple from visible radiation. Additionally, a silicone elastomer was used to maintain the thermal interface between the lens surface and the thermocouple junction bead. With these precautions, the lens temperature measurements made using the J-type thermocouple and the IR imaging system matched very well.

Keywords: light-emitting diode, lens surface temperature, thermocouple, IR thermal imaging system, thermocouple shielding

1. INTRODUCTION
The gallium nitride (GaN) based light-emitting diode (LED) technology has improved significantly over the past decade and now emits high radiant power, of the order of watts per chip. Past studies have reported shortened LED package life due to encapsulant degradation caused by high temperature [1],[2]. High radiation, especially short wavelength, can increase the temperature of the primary lens due to absorption [2]. To minimize lens degradation and improve LED performance, it is necessary to measure the lens temperature accurately during operation. Past studies have shown large measurement errors when using thermocouples in high visible radiant flux environments [3],[4]. Therefore, the objective of this study was to understand the problem in using thermocouples to measure LED lens surface temperature and to find a solution to improving the measurement accuracy.

A thermocouple consists of two electrical conductors that are made of dissimilar metals [5]. These electrical conductors are joined together by either welding or soldering, ensuring good electrical contact at the junction. When the temperature at the thermocouple junction increases, a voltage difference is induced across the ends of the two conductors. This voltage difference is related to the temperature at the junction and the electrical properties of the two conductors. Measuring temperature with the use of a thermocouple is very common and is classified as an intrusive measurement [5]. Measurement errors can be caused by thermocouple geometry, insertion, and heat transfer interactions [5]. Several photometric measurement standards, even though they do not explain the reason, recommend shielding the thermocouple from direct radiation [6].

Based on the findings from past literature, it was hypothesized that the visible radiation from the LED is absorbed by the thermocouple junction and the lead wires, causing large errors in the temperature measurements. Figure 1 indicates radiant flux from an LED package irradiating the thermocouple junction and the lead wires. In addition, energy is transferred to the thermocouple junction via conduction from the primary lens. The figure shows the radiative and convective cooling to and from the ambient environment of the thermocouple junction and the wire leads.

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The J-type thermocouple, a commonly used thermocouple type for measuring temperature, has its positive lead wire metallurgical composition as 99.5% iron and the negative lead metallurgical composition as 55% copper and 45% nickel [7]. Figure 2 shows the absorption spectra for these three metals, adopted from Touloukian and DeWitt [8]. The figure indicates high absorption of visible radiation between 380 to 780 nm wavelength, indicated by the vertical dashed lines, compared to long-wavelength infrared (IR) radiation.

2. INFRARED THERMOMETRY FOR TEMPERATURE MEASUREMENT

Infrared (IR) thermometry has been used in the electronics and LED industries to measure surface temperatures as an alternative to intrusive thermocouple temperature measurements [9],[10]. Equipment spectral sensitivity, calibration, and knowledge of the target surface emissivity becomes important in obtaining accurate and repeatable measurements with IR thermometric equipment [9],[10]. Generally, IR thermographic systems are designed to be spectrally sensitive in 3-5 μm and 7-14 μm wavelength ranges [10]. Since IR thermographic equipment is not sensitive to the visible spectrum (0.38-0.78 μm), it is an ideal reference sensor for measuring the surface temperature of an LED primary lens [10].
An IR imaging camera with a spectral sensitivity range of 7.5-14 μm was used in this study. To determine the temperature of a target surface accurately using IR thermography, the surface emissivity of the target needs to be determined [10]. A preliminary experiment was conducted to estimate the LED primary lens surface emissivity based on the recommended practices in the IR thermometric community [10].

An experiment was conducted to verify the hypothesis, in which the thermocouple-measured temperature would have a positive error in a visible radiant flux environment, while both the thermocouple and the IR imaging method would provide similar temperature measurements if there was no visible radiant flux on the thermocouple. A multi-chip LED package with a single primary lens attached to a heat sink was used in this experiment.

Figure 3 shows the location where a thermocouple was attached to the case temperature (Tc) location, with the use of thermal epoxy for measuring case temperature. A 5×5 mm² square of general purpose black electrical tape was adhered on to the LED package board as the reference for the IR temperature measurement at the case temperature location, as illustrated in Figure 3. A J-type thermocouple and the IR imaging camera were used alternatively to measure the LED package lens geometric center (GC) temperature. No thermal interface material was used for the thermocouple measurements at the LED package’s geometric center. The LED package primary lens surface emissivity was assumed to be 0.97 based on past experiments.

Table 1 shows the results of this experiment where the thermocouple-measured and the IR imaging camera-measured temperatures at the case temperature (Tc) location were similar. However, the geometric center (GC) temperature measurement was higher with the thermocouple.

Table 1. LED package lens geometric center temperature and case temperature measured with J-type thermocouple and IR imaging camera. The numbers within parentheses indicate the deviation of the thermocouple temperature measurement from the IR imaging camera-measured temperature.

<table>
<thead>
<tr>
<th>Drive current (mA)</th>
<th>IR @ GC avg. temp. (°C)</th>
<th>Thermocouple @ GC avg. temp. (°C)</th>
<th>IR @ Tc avg. temp. (°C)</th>
<th>Thermocouple @ Tc avg. temp. (°C)</th>
</tr>
</thead>
<tbody>
<tr>
<td>300</td>
<td>51.8</td>
<td>55.4 (+7%)</td>
<td>47.0</td>
<td>47.2 (+1%)</td>
</tr>
<tr>
<td>700</td>
<td>81.3</td>
<td>90.1 (+11%)</td>
<td>83.6</td>
<td>84.8 (+1%)</td>
</tr>
<tr>
<td>1000</td>
<td>100.1</td>
<td>110.5 (+10%)</td>
<td>47.0</td>
<td>47.2 (+1%)</td>
</tr>
</tbody>
</table>
3. SHIELDING OF THERMOCOUPLES

In the previous experiments, the thermocouple radiation error was observed and the ability of IR thermographic techniques to measure the temperature was demonstrated. In order to find a method to reduce the thermocouple absorption of visible radiation emitted by the LED package, the use of highly reflective, commercial grade pipe thread sealant polytetrafluoroethylene (PTFE) (≥99%) material for shielding thermocouple lead wires was investigated.

![Figure 4. Sketch of experimental setup for IR and thermocouple measurement: (a) IR imaging measurement; (b) thermocouple lead wire shielding with PTFE; (c) same as (b) with thermal adhesive tape as a thermal interface material](image)

As shown in Figure 4, the PTFE material was used to wrap the thermocouples from the junction to a length sufficient enough to shield the thermocouple lead wires from being exposed to visible radiation emitted from the LED primary lens. The thermocouple junction was left exposed in order to minimize the negative error from increasing the thermal resistance between the LED package primary lens surface and the thermocouple junction. The shielded thermocouples were calibrated for 0°C and 100°C to ensure the shielding process did not alter the basic operation of the thermocouples.

In order to improve the heat conduction between the thermocouple junction and the LED package lens surface, a square strip of 2x2 mm² white thermal adhesive tape was used, as illustrated in Figure 4(c). The thermocouple junction was pressed into the thermal adhesive tape, as indicated in the figure above, to thin out the thermal adhesive tape and have the thermocouple junction embedded in the thermal tape. The IR imaging camera was used as the reference temperature measurement.

Table 2 shows the temperature measurements from the PTFE-shielded thermocouple with thermal adhesive tape and from the IR imaging camera at the geometric center of the LED package lens surface. The thermocouple measurements were similar to the IR imaging camera-measured temperatures within ±3°C. The numbers within parentheses indicate the deviation of the thermocouple measurements from the IR imaging camera-measured temperature values.

<table>
<thead>
<tr>
<th>Drive current (mA)</th>
<th>GC temp. with IR imaging (°C)</th>
<th>GC temp. with thermocouple with PTFE shielding and thermal tape (°C)</th>
</tr>
</thead>
<tbody>
<tr>
<td>160</td>
<td>36.3</td>
<td>0.5</td>
</tr>
<tr>
<td>780</td>
<td>71.9</td>
<td>0.3</td>
</tr>
<tr>
<td>1100</td>
<td>93.0</td>
<td>0.7</td>
</tr>
</tbody>
</table>
4. ALTERNATIVE THERMAL INTERFACE MATERIALS WITH PTFE-SHIELDED THERMOCOUPLES

In order to check the effect of the thermal adhesive tape on the thermocouple measurement, an optically clear silicone elastomer was used as an alternative thermal interface material. Figure 5 shows the use of optically clear silicone elastomer as an alternative thermal interface material. Due to the use of thermal interface material, the LED package lens surface had to be cleaned after every measurement; therefore, the thermocouple measurements were repeated multiple times with different thermocouples to check repeatability as well. To ensure that the operation of the thermocouples were not compromised after the PTFE shielding process, the shielded thermocouples were calibrated at 0°C and 100°C. The IR imaging camera was used as the reference measurement.

![Diagram of experimental setup](image)

Figure 5. Sketch of the experimental setup: (a) IR imaging measurement; (b) PTFE shielding with thermal adhesive tape; (c) PTFE shielding with silicone elastomer

The results from this experiment are shown in Table 3. The deviation of the thermocouple measurements from the IR imaging temperature measurements are shown within parentheses in the table below. The PTFE shielded thermocouples with thermal adhesive tape and silicone elastomer both measured similar temperatures with deviations of less than +3% from the IR imaging-measured temperatures. The results also illustrated the repeatability of the shielding method with multiple thermocouples.

Table 3. Temperature measurements with PTFE-shielded thermocouples with alternative thermal interface materials

<table>
<thead>
<tr>
<th>Thermocouple No.</th>
<th>Test No.</th>
<th>IR imaging temp. (°C)</th>
<th>PTFE-shielded thermocouple with thermal tape temp. (°C)</th>
<th>PTFE-shielded thermocouple with silicone temp. (°C)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1</td>
<td>96.2</td>
<td>98.1 (+2%)</td>
<td>98.2 (+2%)</td>
</tr>
<tr>
<td></td>
<td>2</td>
<td>96.4</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>3</td>
<td>96.7</td>
<td>97.7 (+1%)</td>
<td>97.3 (+1%)</td>
</tr>
<tr>
<td></td>
<td>4</td>
<td>96.5</td>
<td></td>
<td></td>
</tr>
<tr>
<td>3</td>
<td>5</td>
<td>96.1</td>
<td>96.8 (+1%)</td>
<td>98.7 (+2%)</td>
</tr>
<tr>
<td></td>
<td>6</td>
<td>96.3</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
5. DISCUSSION

The use of unshielded thermocouples to measure primary lens surface temperatures would result in higher measured values due to the absorption of visible radiation emitted by the LED package. IR thermography can be used to accurately measure the lens surface temperature provided that the spectral sensitivity of the IR measurement equipment is not affected by the visible radiant flux of the LED package, the equipment is properly calibrated, and the surface emissivity of the primary lens material of the LED package is known. It was experimentally shown that with proper use of IR thermometry, accurate measurement of LED package lens surfaces is possible. The absorption of visible radiation introduces error, which can be reduced by using a highly reflective thermal insulating material to shield the thermocouple lead wires. The measurement error of these shielded thermocouples with either optically clear silicone elastomer or white thermal tape was within ±3°C of the IR imaging temperature measurement.

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Appendix B

Below is a partial list of thermocouple calibration standards available:


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